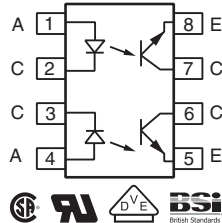
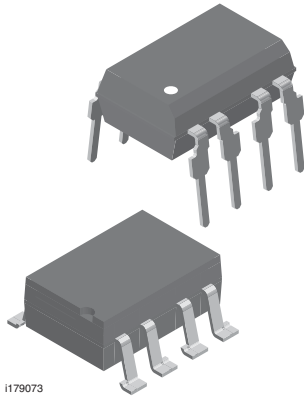


Optocoupler, Phototransistor Output, Dual Channel



FEATURES

- Current transfer ratio, 50 % typical
- Leakage current, 1.0 nA typical
- Two isolated channels per package
- Compliant to RoHS Directive and in accordance to WEEE 2002/96/EC


RoHS
COMPLIANT

AGENCY APPROVALS

- UL1577, file no. E52744 system code H, double protection
- DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-5-5 pending available with option 1
- CSA 93751
- BSI IEC 60950; IEC 60065

DESCRIPTION

The MCT6 is a two channel optocoupler for high density applications. Each channel consists of an optically coupled pair with a gallium arsenide infrared LED and a silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output.

The MCT6 is especially designed for driving medium-speed logic, where it may be used to eliminate troublesome ground loop and noise problems. It can also be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

ORDERING INFORMATION

M **C** **T** **6** **-**

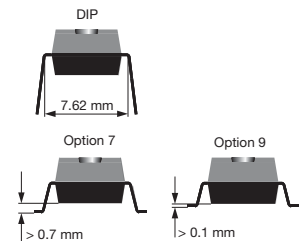
PART NUMBER

X **0** **0** **#**

PACKAGE OPTION

T

TAPE AND REEL



AGENCY CERTIFIED/PACKAGE	CTR
UL, CSA, BSI	≥ 20
DIP-8	MCT6
SMD-8, option 7	MCT6-X007T ⁽¹⁾
SMD-8, option 9	MCT6-X009T ⁽¹⁾
VDE, UL, CSA, BSI	≥ 20
DIP-8	MCT6-X001

Notes

- Additional options may be possible, please contact sales office.
- ⁽¹⁾ Also available in tubes, do not put "T" on the end.



Optocoupler, Phototransistor Output, Vishay Semiconductors Dual Channel

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Rated forward current, DC			60	mA
Peak forward current, DC	1.0 μs pulse, 300 pps	I_{FM}	3.0	A
Power dissipation		P_{diss}	100	mW
Derate linearly from 25 $^{\circ}\text{C}$			1.3	mW/ $^{\circ}\text{C}$
OUTPUT				
Collector current		I_C	30	mA
Collector emitter breakdown voltage		BV_{CEO}	30	V
Power dissipation		P_{diss}	150	mW
Derate linearly from 25 $^{\circ}\text{C}$			2.0	mW/ $^{\circ}\text{C}$
COUPLER				
Isolation test voltage		V_{ISO}	5300	V_{RMS}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	$M \geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{11}$	Ω
Creepage distance			≥ 7.0	mm
Clearance distance			≥ 7.0	mm
Total package dissipation		P_{tot}	400	mW
Derate linearly from 25 $^{\circ}\text{C}$			5.33	mW/ $^{\circ}\text{C}$
Storage temperature		T_{stg}	- 55 to + 150	$^{\circ}\text{C}$
Operating temperature		T_{amb}	- 55 to + 100	$^{\circ}\text{C}$
Lead soldering time at 260 $^{\circ}\text{C}$			10	s

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 20\text{ mA}$	V_F		1.25	1.50	V
Reverse current	$V_R = 3.0\text{ V}$	I_R		0.1	10	μA
Junction capacitance	$V_F = 0\text{ V}$	C_j		25		pF
OUTPUT						
Collector emitter breakdown voltage	$I_C = 1.0\text{ }\mu\text{A}$, $I_E = 10\text{ }\mu\text{A}$	BV_{CEO}	30	65		V
Emitter collector breakdown voltage	$I_C = 10\text{ }\mu\text{A}$, $I_E = 10\text{ }\mu\text{A}$	BV_{ECO}	7.0	10		V
Collector emitter leakage current	$V_{CE} = 10\text{ V}$	I_{CEO}		1.0	100	nA
Collector emitter capacitance	$V_{CE} = 0\text{ V}$	C_{CE}		8.0		pF
COUPLER						
Saturation voltage, collector emitter	$I_C = 2.0\text{ mA}$, $I_F = 16\text{ mA}$	V_{CEsat}			0.40	V
Capacitance (input to output)	$f = 1.0\text{ MHz}$	C_{IO}		0.5		pF
Capacitance between channels	$f = 1.0\text{ MHz}$			0.4		pF
Bandwidth	$I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\text{ }\Omega$			150		kHz

Note

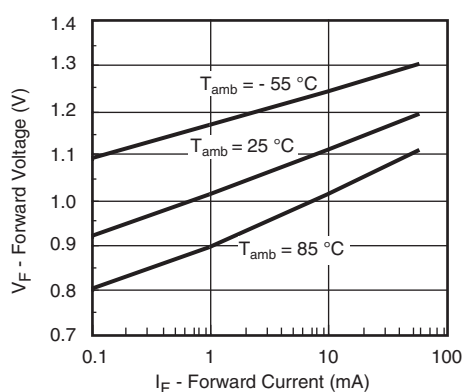
- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
DC current transfer ratio	$I_F = 10\text{ mA}$, $V_{CE} = 10\text{ V}$	CTR_{DC}	20	50		%

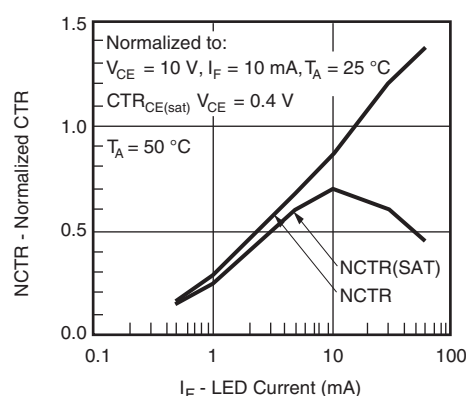
SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Switching times, output transistor	$I_C = 2.0\text{ mA}$, $R_L = 100\text{ }\Omega$, $V_{CE} = 5\text{ V}$	t_{on} , t_{off}		3.0		μs

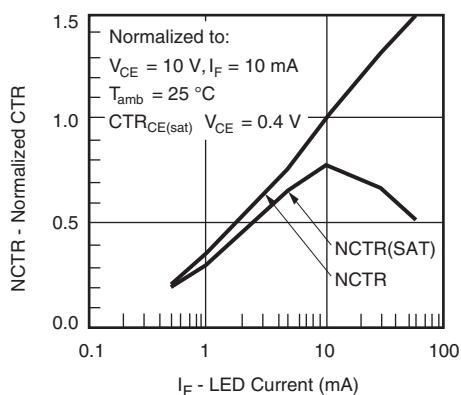
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

iilct6_01

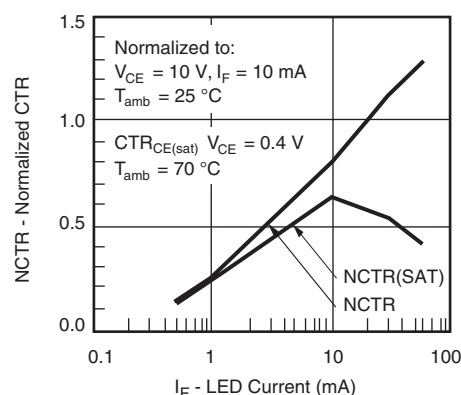
Fig. 1 - Forward Voltage vs. Forward Current



iilct6_03

Fig. 3 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

iilct6_02

Fig. 2 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

iilct6_04

Fig. 4 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

Optocoupler, Phototransistor Output, Vishay Semiconductors Dual Channel

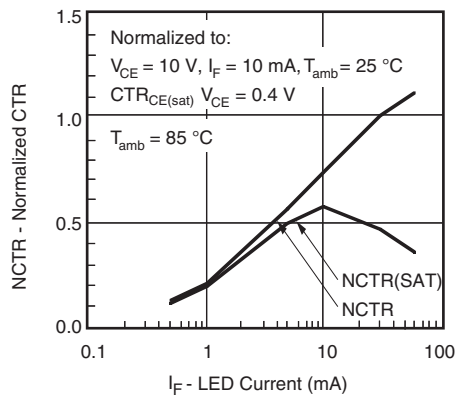


Fig. 5 - Normalized Non-Saturated and Saturated CTR vs. LED Current

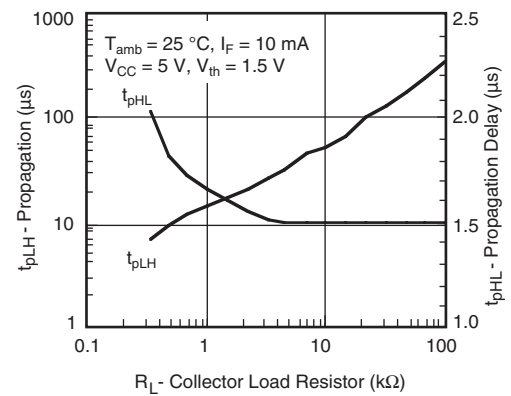


Fig. 8 - Propagation Delay vs. Collector Load Resistor

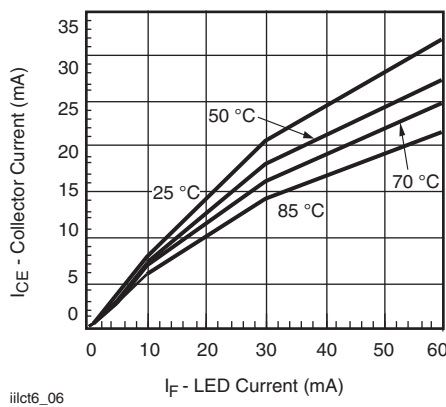


Fig. 6 - Collector Emitter Current vs. Temperature and LED Current

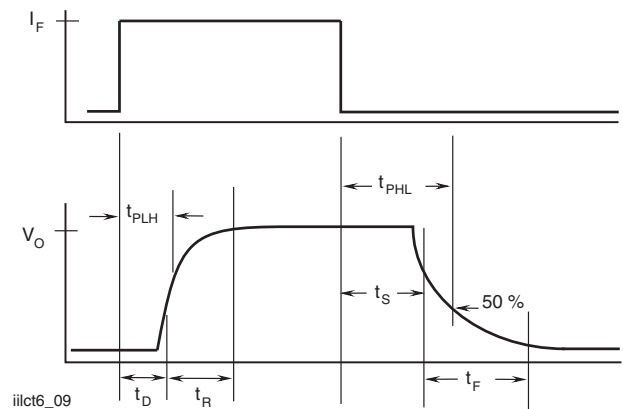


Fig. 9 - Switching Timing

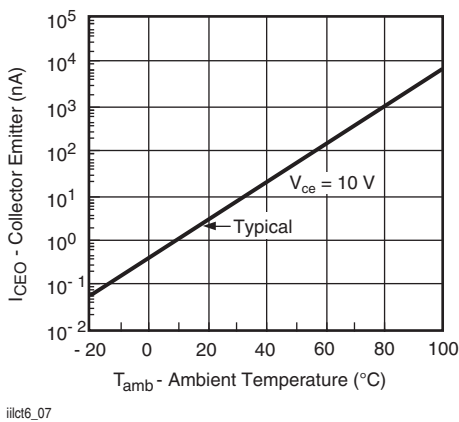


Fig. 7 - Collector Emitter Leakage Current vs. Temperature

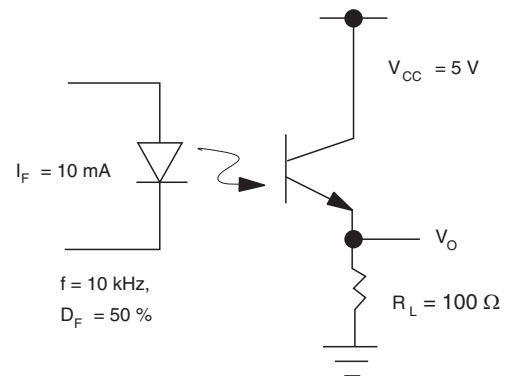
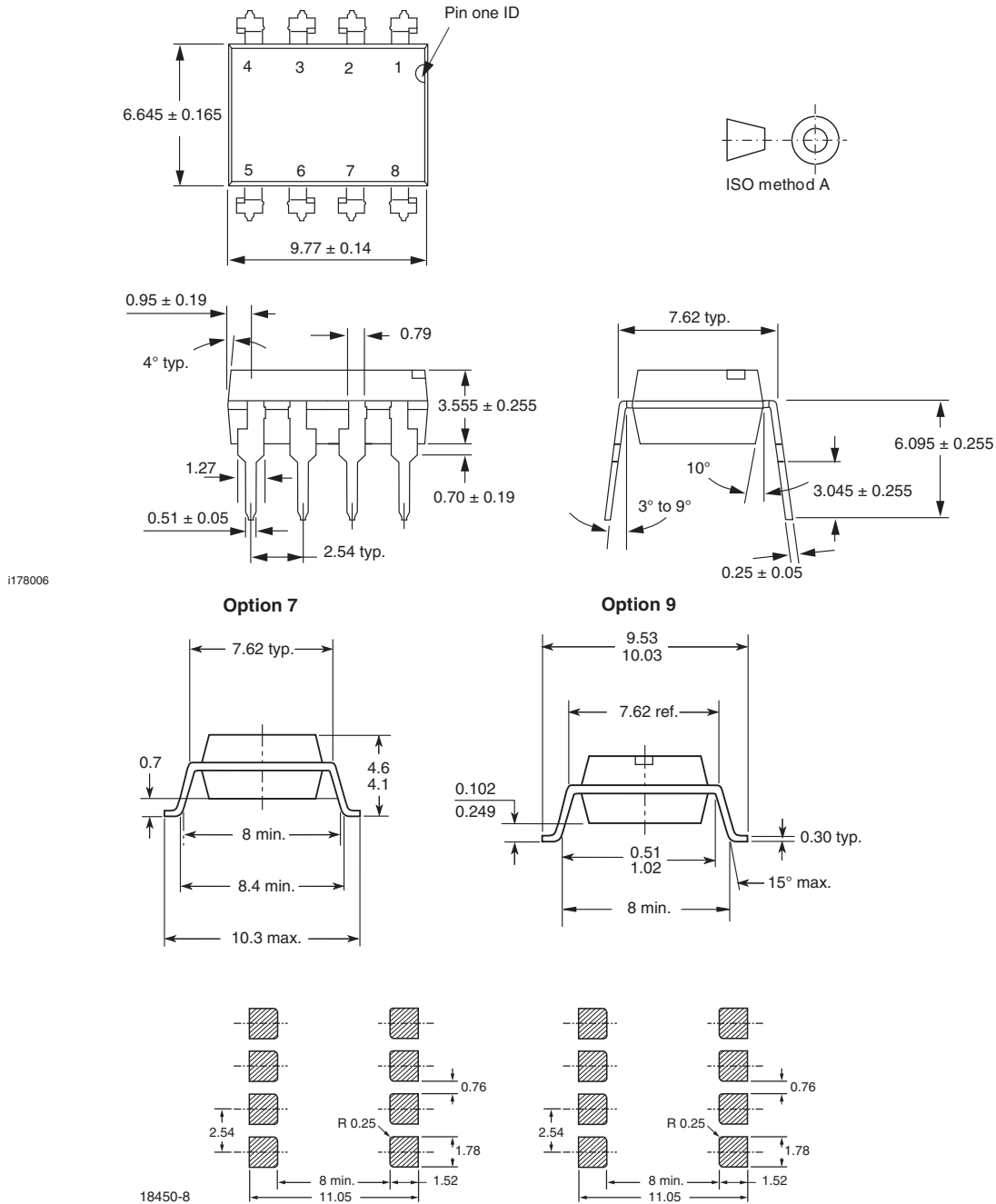
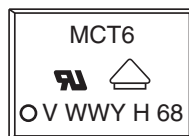


Fig. 10 - Switching Schematic

PACKAGE DIMENSIONS in millimeters



PACKAGE MARKING



Notes

- Only options 1 and 7 reflected in the package marking
- The VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking



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